

Paperboard Packaging Seminar Feb. 21-22, 2018

This seminar provides a comprehensive, hands-on exploration of Paperboard Packaging Technologies. On completing this program, attendees will be equipped to make valuable contributions to critical packaging decisions.

Presentation Topics:

- Paperboard Substrates and Applications
- Paperboard Manufacturing
- Characteristics of Paperboard
- Packaging Sustainability
- Package Design
- Prepress
- Printing and Converting

Hands-On Activities:

- Packaging Materials
- Manufacturing Effects
- Characteristic Test Comparisons
- Packaging Design
- Prepress Activity
- Printing Comparisons
- Die Cutting and Scoring

Who Should Attend:

Individuals involved in package design, sales, specification, purchasing, scheduling, quality control, and production management. This seminar is appropriate for all levels of experience.

Previous Presentation Contributors:

Kapstone Charleston Kraft
WestRock
Clemson University
Bachmann & Associates
Epic Products
Atlas Die
Gallus Printing Machinery
Imerys
Sonoco Products
MacDermid
Graphic Packaging
HP Indigo
Chainalytics
Essentra
DataLase
Recycled Paper Technical Association



\$995/person, \$895/person (Groups of 3+)
More Information & Register - <http://sonocoinstitute.com/courses/paperboard-packaging/>